

RHF-DS01500

RHF76-052 LoRaWAN Module

V0.3

Document information

Info	Content
Keywords	<i>Ai-Thinker, LoRaWAN, Module</i>
Abstract	This document is a datasheet of RHF76-052 LoRaWAN module.

RHF76-052 LoRaWAN Module

Low Power Small Size High integrated LoRaWAN Module

General description

RHF76-052 LoRaWAN Module is a low cost, low power and small size module, embedded with Semtech's LoRa propriety chip SX1276 and ST's ultra-low power MCU STM32L051/052xx. The module designed by Ai-Thinker (Shenzhen) is targeted to application in sensor networking and others IOT device powered by battery which need low power consumption to extend the battery lifetime.

This datasheet will give some details of description of the module, including HW design info, performance validation, and application information.

Applications

The RHF76-052 LoRaWAN Module is designed for end device which need long range and low power consumption, such as metering, sensor networking, and others IOT application.

Key features

- ◆ Low power consumption: 1.45uA sleep current in WOR mode
- ◆ Low cost: SX1276 with cost-effective MCU; 2 layers layout
- ◆ Small size: 23mm X 28mm
- ◆ 33 pins SMT package
- ◆ Dual band: 434MHz/470MHz 868MHz/915MHz
- ◆ High performance: Dual Band: TXOP=20dBm@434MHz/470MHz TXOP=14dBm@868MHz/915MHz Single Band: TXOP=20dBm@868MHz/915MHz 160dB link budget, suitable for long range
- ◆ User-friendly interface SPI; USART; I2C; USB; ADC; 10 more GPIOs
- ◆ LoRaWAN embedded

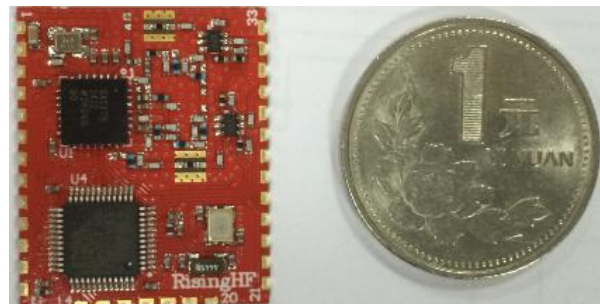


Figure 1 RHF76-052 Module Outline

Content

1.	General description.....	1
1.1	Simplified Block Diagram.....	1
1.2	Pin description.....	2
2.	Electrical Characteristics.....	3
2.1	Absolute Maximum Ratings.....	3
2.2	Operating Range.....	3
2.3	Module Specifications.....	3
3.	Typical Performance Characteristics Measurement.....	5
4.	Application Information.....	9
4.1	Package Information.....	9
4.2	Interface of Module.....	10
4.3	Reference design with RHF76-052 Module.....	10
5.	Application in LoRaWAN.....	11
5.1	LoRaWAN/LoRaMAC.....	11
5.2	RHF76-052 with LoRaWAN.....	11
6.	Ordering information.....	13

Figures

Figure 1 RHF76-052 Module Outline.....	2
Figure 2 Block Diagram of RHF76-052.....	1
Figure 3 Pin diagram.....	2
Figure 4 TXOP vs Supply voltage.....	5
Figure 5 Sensitivity (SF10,125kHz) vs Supply voltage.....	5
Figure 6 Frequency Tolerance vs Temperature.....	6
Figure 7 TXOP vs Temperature.....	6
Figure 8 Sensitivity (SF10,125kHz) vs temperature.....	7
Figure 9 Harmonics measurement @Frf=434MHz, TXOP=20dBm.....	7
Figure 10 Harmonics measurement @Frf=470MHz, TXOP=20dBm.....	8
Figure 11 Harmonics measurement @Frf=868MHz, TXOP=14dBm.....	8
Figure 12 Harmonics measurement @Frf=915MHz, TXOP=14dBm.....	9
Figure 13 package outline drawing.....	9
Figure 14 Recommended land pattern.....	10
Figure 15 Reference design with RHF76-052.....	10
Figure 16 Energy profile of RHF76-052 application in LoRaWAN.....	12
Figure 17 Energy profile of RHF76-052 application in LoRaWAN.....	13

Tables

Table 1 Pin description.....	2
Table 2 Absolute Maximum Ratings.....	3
Table 3 Operating Range.....	3
Table 4 Module Specifications.....	3

This product datasheet contains a detailed description of the RHF76-052 performance and functionality. Please consult with Ai-Thinker for the latest updates, Firmware or errata.

1. General description

The RHF76-052 incorporates SX1276 and STM32L052xx, and is well suited for node in the networking of IOT.

The module has two RF port, RFIO_LF and RFIO_HF. RFIO_LF covers low frequency band, i.e. 434MHz/470MHz. RFIO_HF covers high frequency band, i.e. 868MHz/915MHz.

Based on the powerful functions and performance of SX1276, the RHF76-052 could operates in both (G)FSK and LoRa. In LoRa mode, BW with 62.5kHz, 125kHz, 250kHz and 500kHz could be used.

And with the STM32L051xx/052xx MCU, the module could provide SPI, UART, I2C, ADC and some others GPIOs for customer to extend their application. Two wire interface (SWIM) is suggested to be used for programming.

1.1 Simplified Block Diagram

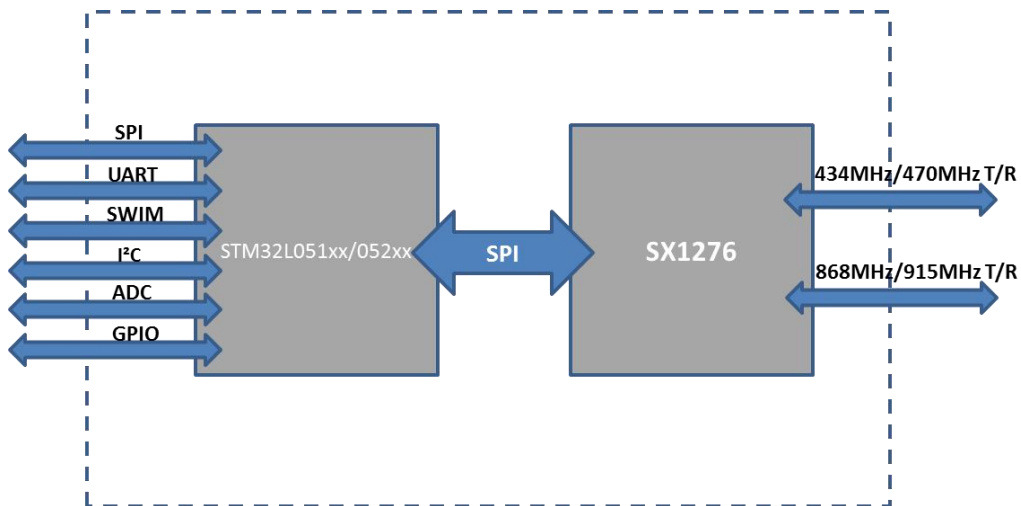


Figure 2 Block Diagram of RHF76-052

1.2 Pin description

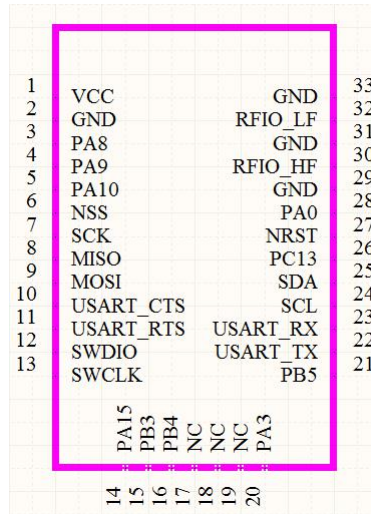


Figure 3 Pin diagram

Table 1 Pin description

Number	Name	Type	Description
1	VCC	-	Supply voltage for the module
2	GND	-	Ground
3	PA8	I/O	GPIO from MCU, PA8
4	PA9	I/O	GPIO from MCU, PA9
5	PA10	I/O	GPIO from MCU, PA10
6	NSS	I/O	NSS of SPI1 from MCU; or GPIO from MCU, PB12
7	SCK	I/O	SCK of SPI1 from MCU; or GPIO from MCU, PB13
8	MISO	I/O	MISO of SPI1 from MCU; or GPIO from MCU, PB14
9	MOSI	I/O	MOSI of SPI1 from MCU; or GPIO from MCU, PB15
10	USART1_CTS	I/O	USART1_CTS from MCU; or GPIO from MCU, PA11
11	USART1_RTS	I/O	USART1_RTS from MCU; or GPIO from MCU, PA12
12	SWDIO	I/O	SWDIO of SWIM for program download
13	SWCLK	I/O	SWCLK of SWIM for program download
14	PA15	I/O	GPIO from MCU, PA15
15	PB3	I/O	GPIO from MCU, PB3
16	PB4	I/O	GPIO from MCU, PB4
17	NC	-	Connected to Ground
18	NC	-	Connected to Ground
19	NC	-	Connected to Ground
20	PA3/ADC3	I/O	GPIO from MCU, PA3; or ADC3 input
21	PB5	I/O	GPIO from MCU, PB5
22	USART1_TX	I/O	USART1_TX from MCU; or GPIO from MCU, PB6

23	USART1_RX	I/O	USART1_RX from MCU; or GPIO from MCU, PB7
24	I2C_SCL	I/O	SCL of I2C from MCU; or GPIO from MCU, PB8
25	I2C_SDA	I/O	SDA of I2C from MCU; or GPIO from MCU, PB9
26	PC13/Wkup2	I/O	Wake up pin for MCU; or GPIO from MCU, PC13
27	NRST	I	Reset trigger input for MCU
28	PA0/AD0	I/O	GPIO from MCU, PA0; or ADC0 input
29	GND	-	Ground
30	RFIO_HF	-	RF input/output in high band, i.e. 868MHz/915MHz
31	GND	-	Ground
32	RFIO_LF	-	RF input/output in low band, i.e. 434MHz/470MHz
33	GND	-	Ground

2. Electrical Characteristics

2.1 Absolute Maximum Ratings

Stresses above the values listed below may cause permanent device failure. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Table 2 Absolute Maximum Ratings

Item	Description	min	max	unit
VCCmr	Supply voltage	-0.3	+3.9	V
Tmr	Temperature	-55	+115	°C
Pmr	RF input level	-	+10	dBm

2.2 Operating Range

Table 3 Operating Range

Item	Description	min	max	unit
VCCop	Supply voltage	+1.8	+3.6	V
Top	Temperature	-40	+85	°C
Pop	RF input level	-	+10	dBm

2.3 Module Specifications

Table 4 Module Specifications

ITEMS	Parameter	Specifications	Unit
Structure	Size	23(W) X 28(L) X 2.6(H)	mm
	Package	33 pins, SMT	

Electrical Characteristics	power supply	3.3V type	V
	Sleep current	1.45uA	uA
	Operation current (Transmitter+MCU)	120mA @20dBm in 434MHz/470MHz type	mA
		45mA @14dBm in 868MHz/915MHz type	mA
	Operation current (Receiver+MCU)	16mA @BW125kHz, 434MHz/470MHz type	mA
		15.5mA @BW125kHz, 868MHz/915MHz type	mA
	Output power	20dBm max @434MHz/470MHz	dBm
		14dBm max @868MHz/915MHz	dBm
	Sensitivity	-139dBm @SF12, BW125kHz, 434MHz/470MHz	dBm
		-137dBm @SF12, BW125kHz, 868MHz/915MHz	dBm
Harmonics (LF)	<-42dBm below 1GHz	dBm	
	<-35dBm above 1GHz	dBm	
Harmonics (HF)	<-40dBm above 1GHz	dBm	
Interface	RFIO_LF	RF port for Low Band (434MHz/470MHz)	
	RFIO_HF	RF port for High Band (868MHz/915MHz)	
	SPI	1 group of SPI, include 4 pins	
	USART	1 group of USART, include 2pins	
	USB	1 group of USB, include 2 pins	
	I2C	1 group of I2C, include 2 pins	
	ADC	2 ADC Input, include 2 pins	
	GPIOs	8 GPIOs more except the interface above	
	NRST	Manual reset pin input	

3. Typical Performance Characteristics Measurement

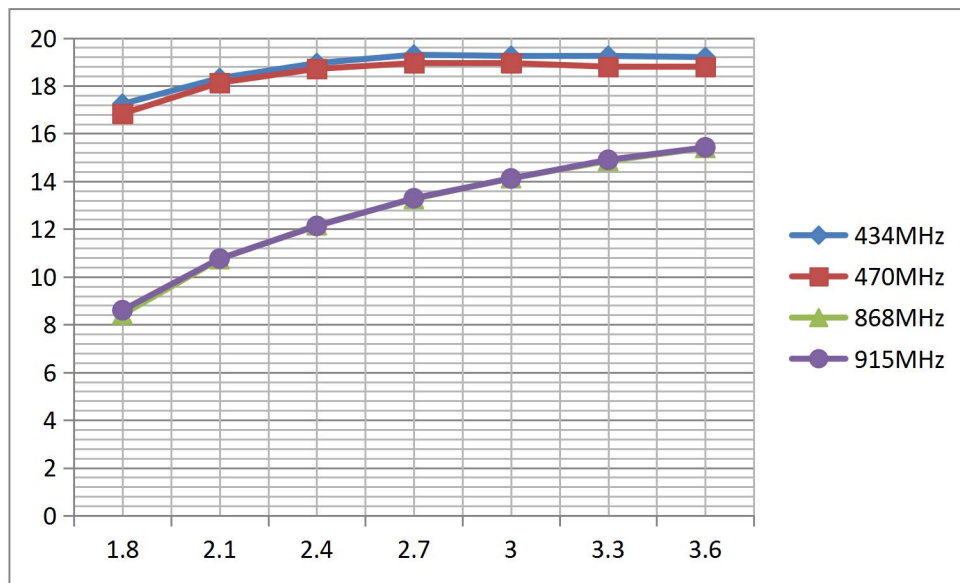


Figure 4 TXOP vs Supply voltage

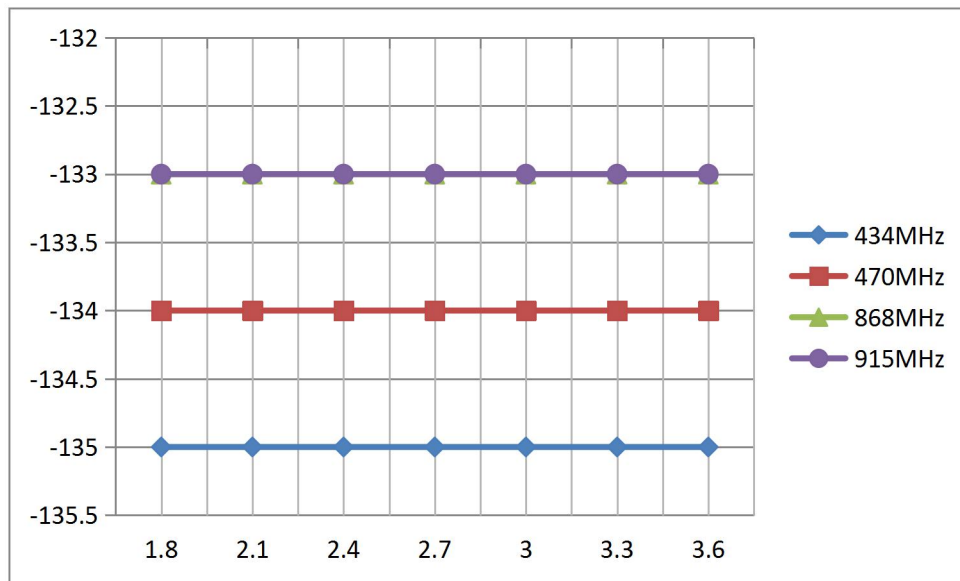


Figure 5 Sensitivity (SF10,125kHz) vs Supply voltage

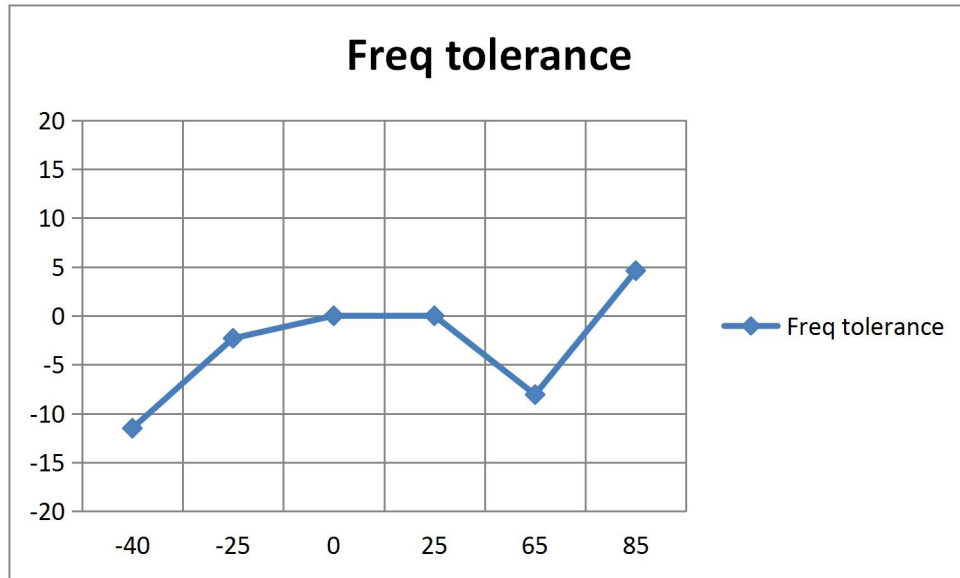


Figure 6 Frequency Tolerance vs Temperature

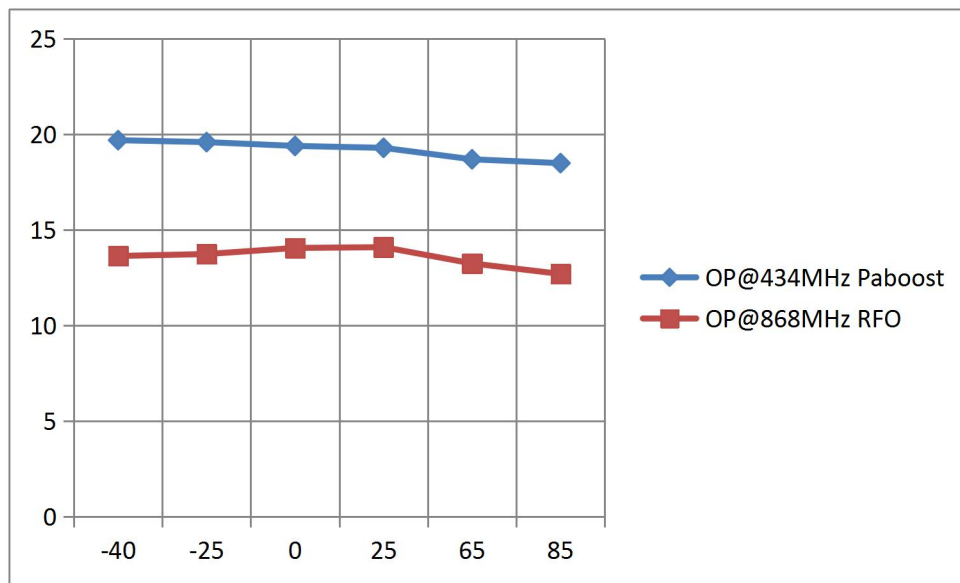


Figure 7 TXOP vs Temperature

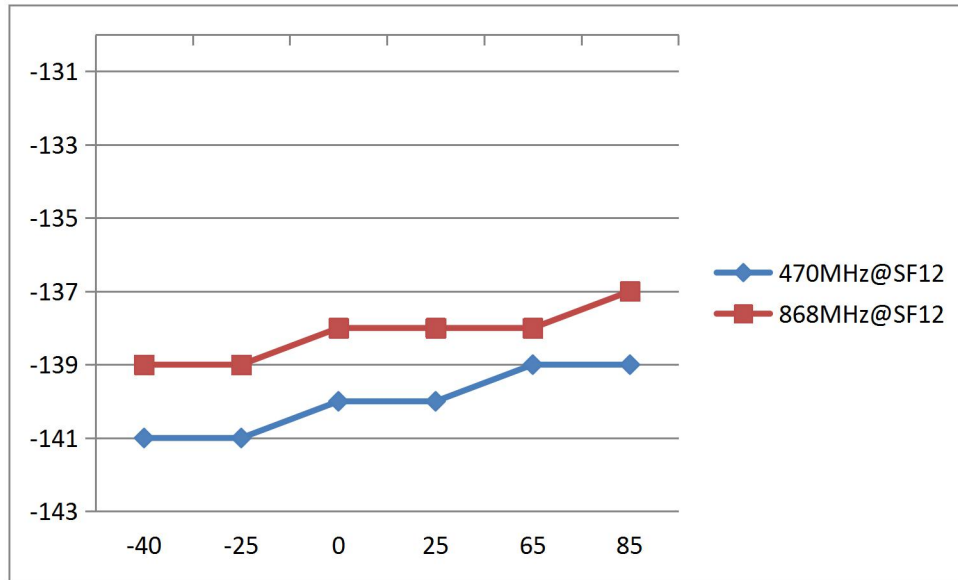


Figure 8 Sensitivity (SF10,125kHz) vs temperature

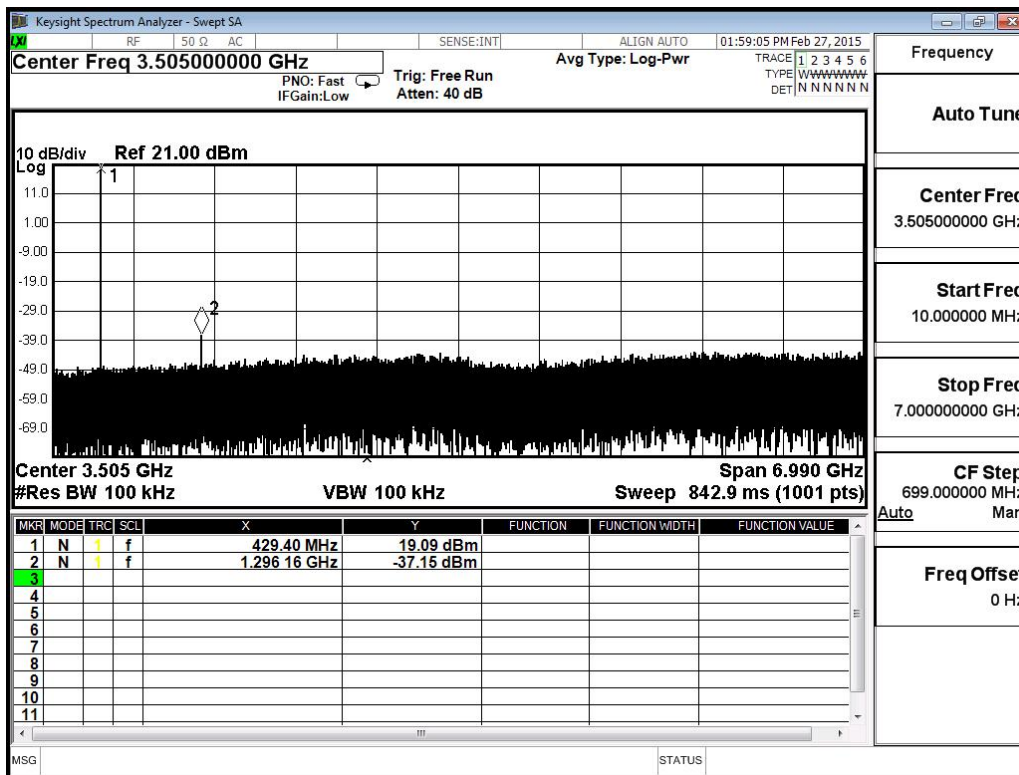


Figure 9 Harmonics measurement @Frf=434MHz, TXOP=20dBm

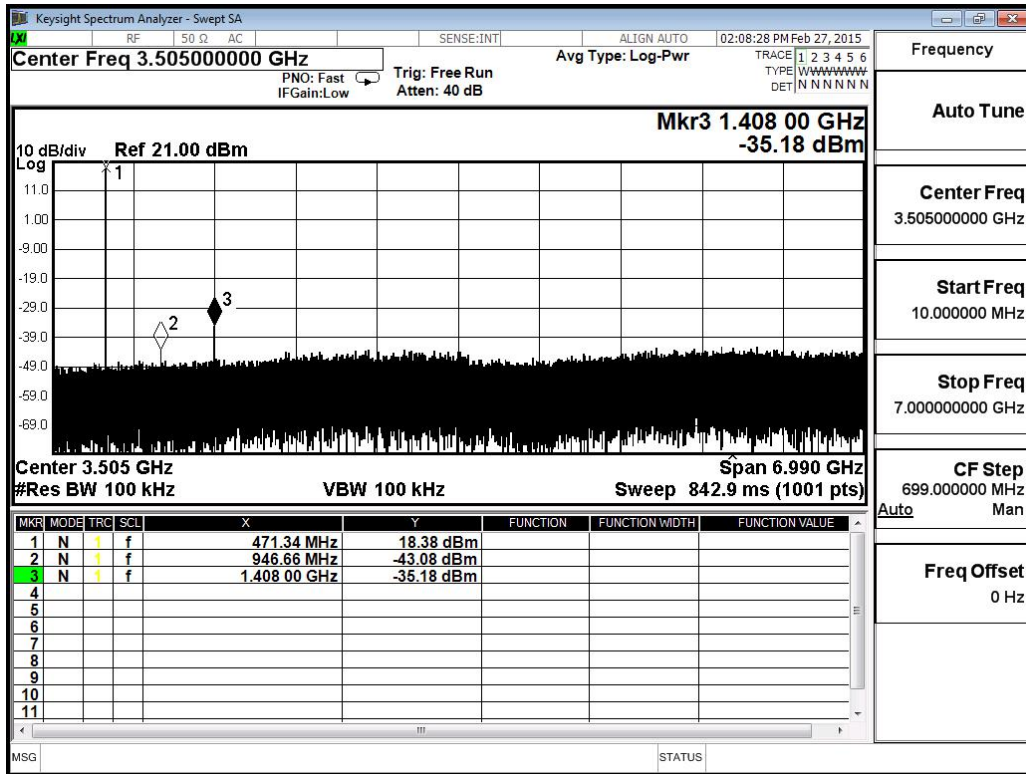


Figure 10 Harmonics measurement @Frf=470MHz, TXOP=20dBm

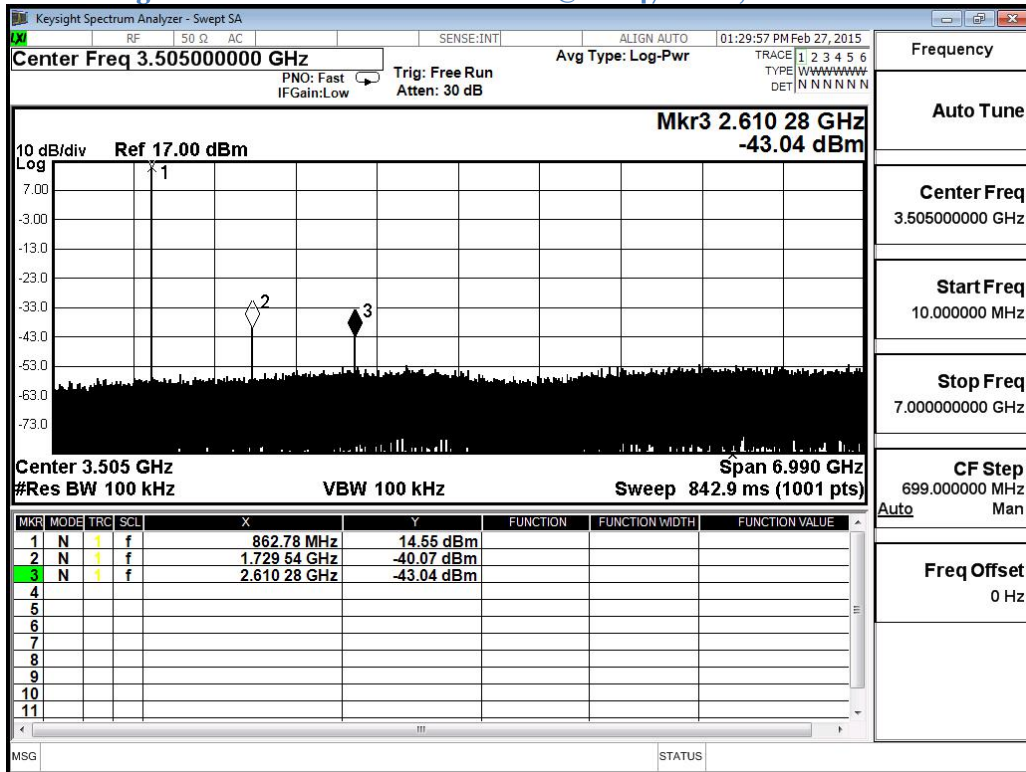


Figure 11 Harmonics measurement @Frf=868MHz, TXOP=14dBm

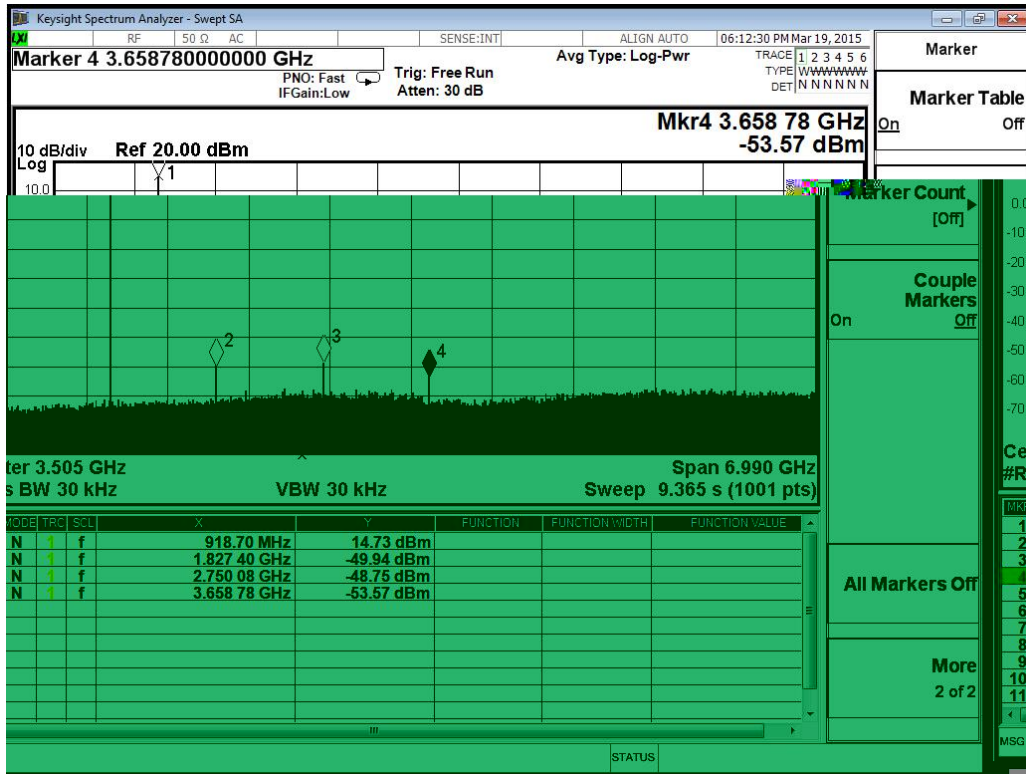


Figure 12 Harmonics measurement @Frf=915MHz, TXOP=14dBm

4. Application Information

4.1 Package Information

The RHF76-052 is available in a 33-lead SMD package as shown in Figure 5 below:

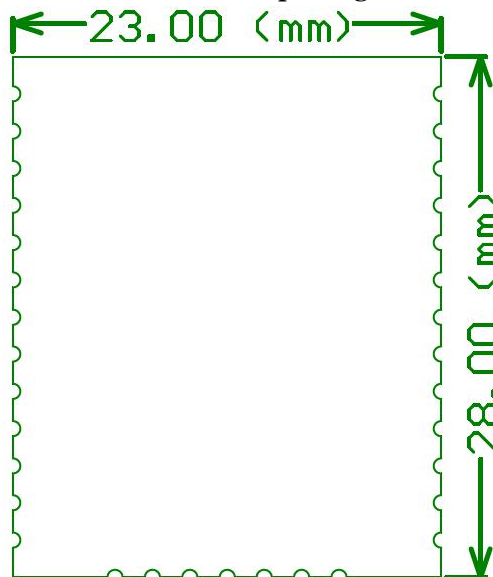


Figure 13 package outline drawing

Figure 6 show the recommended land pattern for layout.

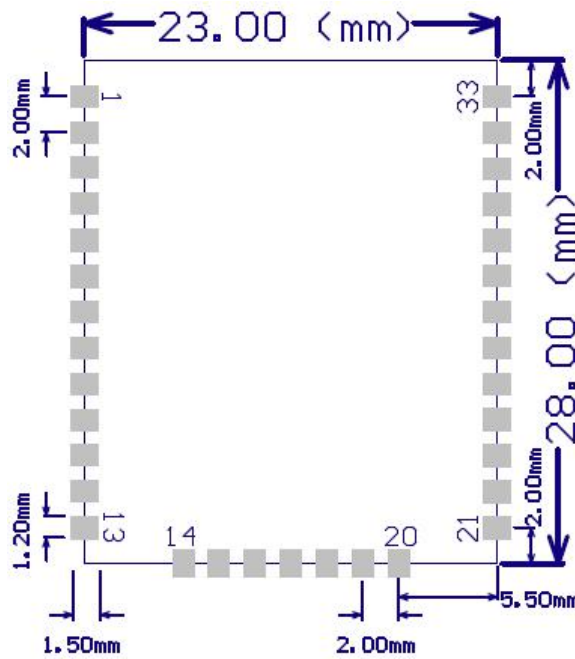


Figure 14 Recommended land pattern

4.2 Interface of Module

Except that several essential GPIOs and one group of SPI would be used for internal transceiver control, all others GPIOs and interface of the MCU would be connected to external pins of the module, which includes SPI, USART, I2C, USB and 10 GPIOs. And there are 2 ADC included in the 10 GPIOs. This is very useful and important for customer to extend their design with these abundant GPIOs and interfaces. For more details of interface, please refer to Table 1 Pin description and datasheet of STM32L051xx/STM32L052xx.

4.3 Reference design with RHF76-052 Module

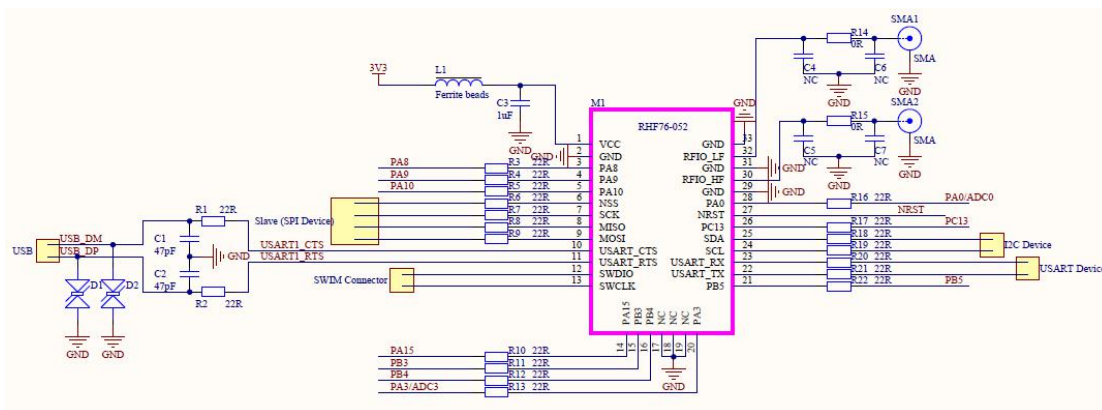


Figure 15 Reference design with RHF76-052

5. Application in LoRaWAN

5.1 LoRaWAN/LoRaMAC

LoRaWAN networks typically are laid out in a star-of-stars topology in which gateways relay messages between end-devices and a central network server at the backend. Gateways are connected to the network server via standard IP connections while end devices use single-hop LoRa™ or FSK communication to one or many gateways. All communication is generally bi-directional, although uplink communication from an end device to the network server is expected to be the predominant traffic. Communication between end-devices and gateways is spread out on different frequency channels and data rates. The selection of the data rate is a trade-off between communication range and message duration, communications with different data rates do not interfere with each other. LoRa data rates range from 0.3 kbps to 50 kbps, with different Band Width and Spreading Factor. To maximize both battery life of the end-devices and overall network capacity, the LoRa network infrastructure can manage the data rate and RF output for each end-device individually by means of an adaptive data rate (ADR) scheme.

End-devices may transmit on any channel available at any time, using any available data rate, as long as the following rules are respected:

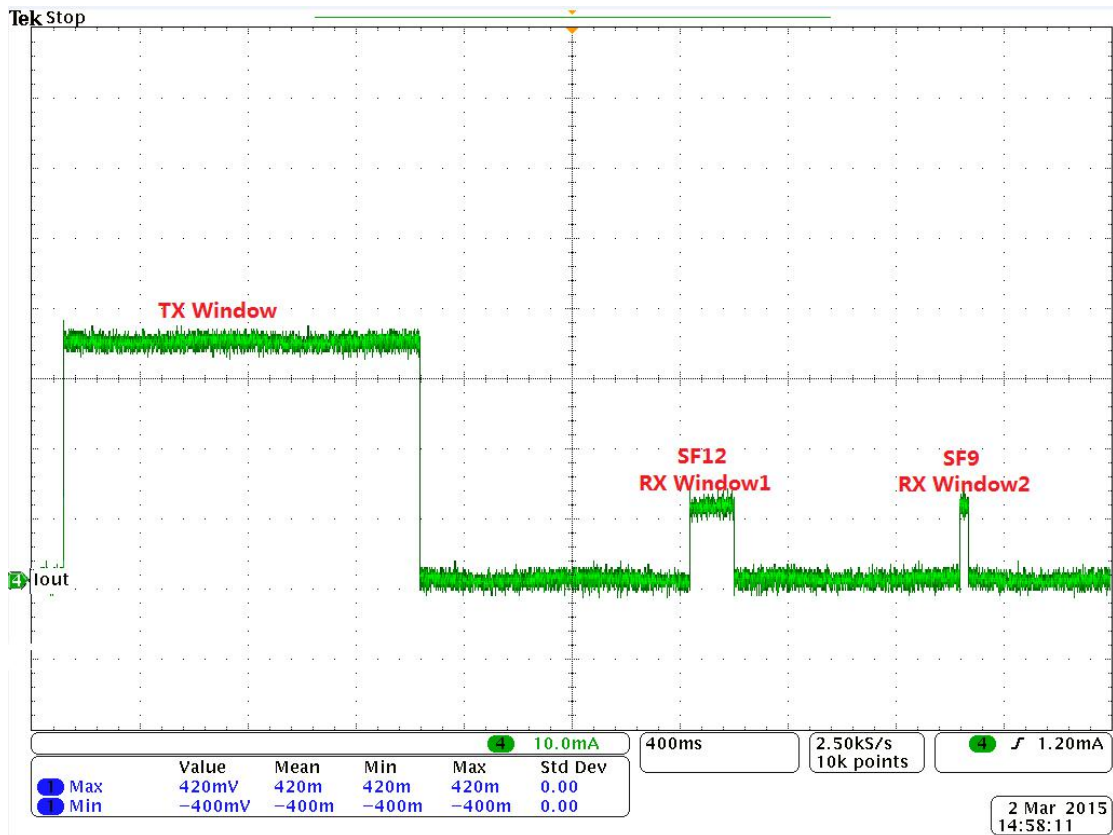
- 1) The end-device changes channel in a pseudo-random fashion for every transmission. The resulting frequency diversity makes the system more robust to interferences.
- 2) The end-device respects the maximum transmit duty cycle relative to the sub-band used and local regulations.
- 3) The end-device respects the maximum transmit duration (or dwell time) relative to the sub-band used and local regulations.

The RHF76-052 Module incorporates Semtech's LoRa Chip SX1276 and ST's ultra-low power MCU. With only 1.45uA sleep current in WOR mode, the module is really very suitable for LoRaWAN application.

5.2 RHF76-052 with LoRaWAN

The Figure 16 and Figure 17 below show the power consumption of the RHF76-052 module. The code is organized so that the MCU and all peripherals are in sleep mode most of the time.

In Figure 16, two RX windows will follow the TX window which is in accordance with LoRaWAN protocol. In the RX window1, the SF of the receiver would set to SF12 for example (should be same as the SF when transmit before). When there is no packet received in the RX window1, the RX window2 would occur. In the RX window2, the SF of the receiver would set to SF9.



**Figure 16 Energy profile of RHF76-052 application in LoRaWAN
(No packet received from Server)**

In Figure 17, the node receive the packet from server in the RX window1.

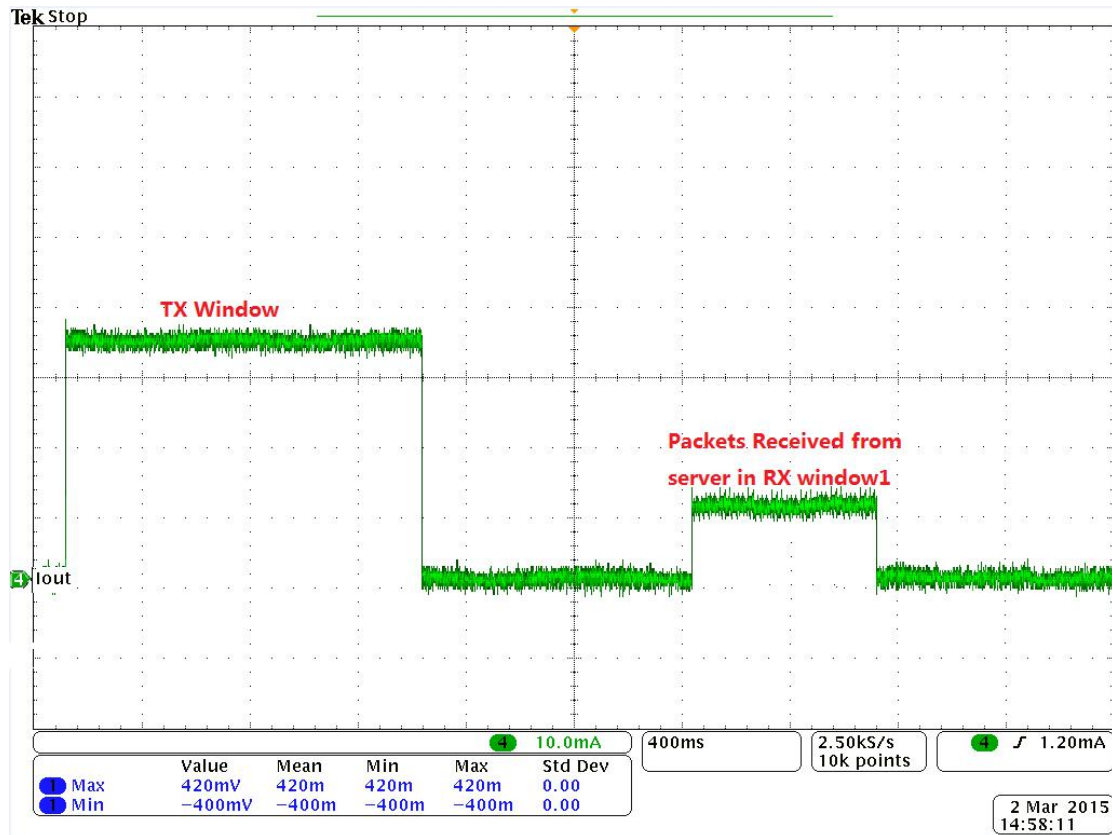


Figure 17 Energy profile of RHF76-052 application in LoRaWAN
(A packet received from Server in RX window1)

6. Ordering information

Contact: Support@Ai-Thinker.com

Part number	Band	Max OP@Low band (434MHz/470MHz)	Max OP@High band (868MHz/915MHz)	MCU	Description
RHF76-052A	dual band	20dBm	14dBm	STM32L052C8T6	USB
RHF76-052C	Single Band	NC	20dBm	STM32L052C8T6	USB
RHF76-051A	dual band	20dBm	14dBm	STM32L051C8T6	Without USB
RHF76-051C	Single Band	NC	20dBm	STM32L051C8T6	Without USB

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